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Features

- Protection for power electronics on 28VDC avionics or industrial power bus to DO-160, Category Z, Abnormal Surge Voltage (DC) levels.
- Controls power P-FET to clamp transient at 34V.
- Small foot print (8L SOIC NB).
- Wide input voltage range.
- Programmable Undervoltage Lockout.
- Logic compatible On/Off input.
- Stable over temperature.
- Soft start delay.

General Description



DEI 1028

Voltage Clamping

Circuit

The DEI1028 is a control circuit for a 28VDC power bus voltage clamp. It is designed for use as the front end to a 28VDC input power supply to provide transient voltage protection. It controls the gate drive of a P-Channel power MOSFET to linearly clamp the output during over-voltage transients. The output voltage is maintained below the clamping threshold of 35V (max) which is adequate to protect most Commercial-Off-The-Shelf switching supplies, linear regulators, and op amps.

There is an Undervoltage Lockout feature that shuts the Power MOSFET off when the input voltage is below a user programmed threshold. An open collector logic output annunciates the under-voltage status. There is also a logic on/off input which may be used to control the power circuit. An external capacitor may be used to set a delay from when input power is applied to when the MOSFET is turned on.

		Table 1: Pin Definitions	
Pin #	Name	Description	Din Diagram
1	GATE	OUTPUT . Controls the gate of the external p-channel power MOSFET.	Pin Diagram
2	САР	IN/OUT . Controls the soft start delay of the device. Use 0.22uF for 200ms minimum soft start time.	
3	IN	INPUT . Power input for the DEI1028 Voltage Clamp.	CAP 2 7 GNI
4	UVL	INPUT . Controls the under voltage lockout condition of the device.	
5	NON	INPUT. Logic low enables device. Logic high disables device.	
6	NUV	OUTPUT . Open collector output. Active low when IN is below UVL threshold.	
7	GND	POWER. Ground	
8	OUT	INPUT. Feedback to gate control from drain of Power MOSFET.	

	Parameter	Symbol	Rating	Units
IN Pin:	Relative to GND Continuous 1 ms Transien 100 ms Transien	t V _{IN}	0 to +40 -50 +100	V V V
UVL Pin:	Relative to V _{IN}	V _{UVL}	-6 to +0.5	V
CAP Pin:	Relative to V _{IN}	V _{CAP}	-20 to +20	V
GATE Pin:	Relative to V _{IN}	V _{GATE}	-10 to +0.5	V
NON Pin:	Relative to GND	V _{NON}	-0.5 to + 6.0	V
NUV Pin:	Relative to GND	V _{NUV}	-0.5 to + 20	V
OUT Pin:	Relative to GND	V _{OUT}	-0.5 to + 40	V
Operating Tempe	rature	ТА	-55 to +125	°C
Storage Tempera	ture	T _{STG}	-65 to +125	°C
Peak Body Ttemp - G Packa			260	°C

Table 3: Operating Characteristics — (Ta = -55 °C to 85/105°C)							
Parameter	Symbol	Conditions	Min	Тур	Max	Units	
Clamp output voltage	V _{O(CL1)}	V _{IN} = 40 V, 60V	33		35	V	
Clamp output voltage	V _{O(CL2)}	V _{IN} = 80 V	33		35	V	
Clamp output voltage	Vo _(CL3)	$V_{IN} = -50 V^{(1,2)}$	-	-	-		
Source-Gate FET voltage (ON)	V _{SG(1)}	RUVL = 13.6 kΩ, VIN = 14 V	9		10	V	
Source-Gate FET voltage (OFF)	V _{SG(2)}	RUVL = 13.6 kΩ, VIN = 10 V	0		0.7	V	
Source-Gate FET voltage (ON)	V _{SG(1)}	RUVL = 7 kΩ, VIN = 25 V	9		10	V	
Source-Gate FET voltage (OFF)	V _{SG(2)}	RUVL = 7 kΩ, VIN = 19.5 V	0		0.7	V	
Source-Gate FET voltage (LINEAR)	V _{SG(3)}	35V < V _{IN} ≤ 80V, VOUT= Clamp Voltage (33-35V)	0.7		9	V	
Turn-on time	t _{on}	$C = 0.22 \mu F$; see Figures 4 and 5.	200			msec	
Power-on delay charge current	I _{ST}	V _{IN} > 10V	0.75		3	μA	
Power-on delay threshold	V _{ST}	V _{IN} > 10V	V _{IN} - 2.2		$V_{IN} - 0.7$	V	
Output overshoot voltage	Vo _{MX}	See Figure 6. ⁽¹⁾			35	V	
Output settling time	ts	See Figure 6. ⁽¹⁾			2	msec	
Supply Current	I _{IN}	V _{IN} = 30 V			5	mA	

Notes:

1.

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Guaranteed by design and not production tested. Device must survive this test. Duration of negative voltage must be limited to less than 1 ms due to heating effects. MOSFET capacitance (Cgs) must be in the range 500 ~ 5000 pF. If below 500 pF, an external 470 pF capacitor must be connected between the DEI1028 OUT and GATE pins. 3.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
NON input logic 1 level	VIH	V _{IN} = 8 to 30 V	2.8			V
NON input logic 0 level	V _{IL}	V _{IN} = 8 to 30 V			0.8	V
NON input logic 0 current	I _{IL}	V _{NON} = 0 V V _{IN} = 8 to 30 V	-300		-30	μA
NUV output logic 1 level	V _{OH}	R_{UVL} = 13.6 kΩ, V _{IN} = 14 V, R_{PU} = 10 kΩto 5V (See Figure 7.)	4.75			V
NUV output logic 0 level	V _{OL}	$R_{UVL} = 13.6 k\Omega$, $V_{IN} = 10 V$ $I_{OL} = 420 µA$ (See Figure 7.)			0.8	V

Gate Drive

The DEI1028 device is designed to control the gate of a P-Channel power MOSFET such as the IRF9540. At normal operation the gate output turns the transistor ON to saturation. Below under voltage conditions the MOSFET is shut off. In clamp mode the MOSFET is driven to linear mode, keeping the output at approximately 34 V.

Undervoltage Lockout

An Undervoltage Lockout feature is provided to prevent large currents from flowing through the MOSFET if the input voltage is too low. The resistor is placed between the IN and UVL pins. The following formula is used to determine the resistor value to set the nominal (25 °C) lockout threshold voltage:

$$R_{UVL} = 100K \times \frac{1.45}{(V_{UVL} - 1.45)}$$

See Tab 5 and Figs 2 & 3 for temperature characteristics.

Power On Delay

An external capacitor between CAP and the input voltage may be used to set a turn on delay time. See figure 4.

Ton(ms) ≈ Css(nF)

At start up, the voltage across the capacitor is approximately zero, the voltage at the CAP pin is approximately the input voltage, and the MOSFET is turned off. The 1028 CAP pin provides a current sink (approx. 2uA) to charge the capacitor. The 1028 turns the MOSFET on when the voltage across the capacitor reaches approximately 1.5V.

Safe Operating Area

The device protects against an 80V spike of \leq 100ms duration, and provides overshoot protection. Pulses greater than 80V may cause the device to remove drive to the external FET, turning it off and causing the output to go below its clamped output voltage regulation level. This effect is worse at low temperature. The device provides conditioned power with Vin \leq 80V, as described in DO160 Sect 16 Category Z "Typical Abnormal DC Surge Voltage Characteristics". See Figure 8.

Surge Operation

As shown in Fig. 8, surges \leq 80V will regulate and protect. For surges >80V, the device may lose drive to the external FET, but will continue to protect the output. The application designer must consider the safe operating area of the external FET separately.

Table 5: Under voltage Lockout Threshold						
R _{UVL}	TEMP	SYMBOL	MIN	TYP	MAX	UNITS
13.6K	105 ºC	V _{IN}	12.0		15.0	V
13.6K	85 °C	V _{IN}	12.0	-	14.0	V
13.6K	25 °C	V _{IN}	11.0	-	13.0	V
13.6K	-55 °C	V _{IN}	10.0	-	12.0	V
7K	105 ⁰C	V _{IN}	22.0		25.0	V
7K	85 °C	V _{IN}	22.0	-	25.0	V
7K	25 °C	V _{IN}	21.0	-	23.0	V
7K	-55 °C	V _{IN}	19.5	-	21.5	V

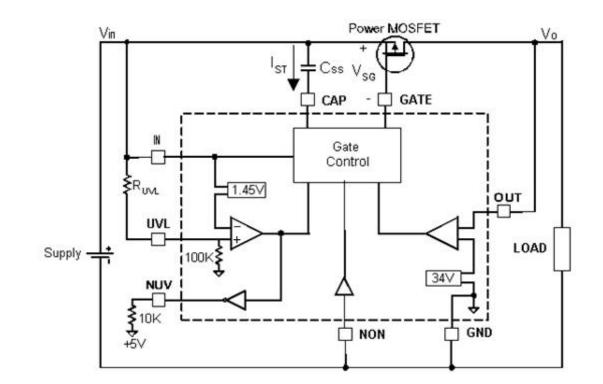
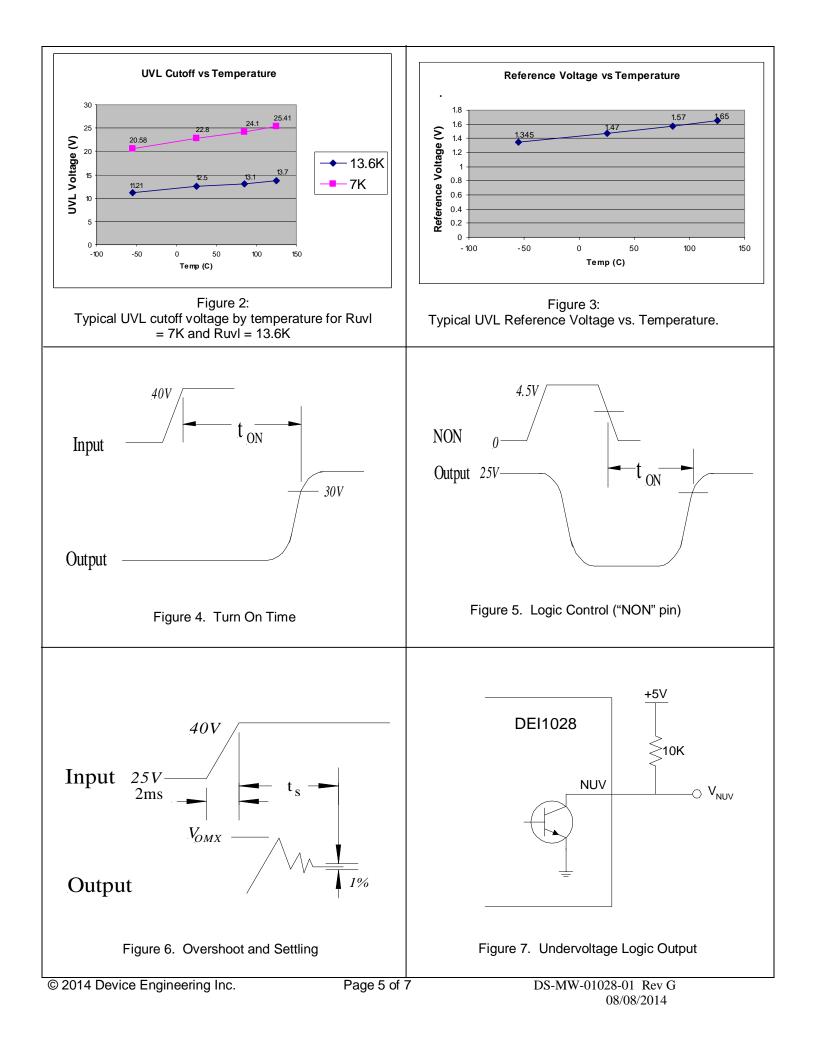


Figure 1: Typical Application (Power MOSFET is External to IC)



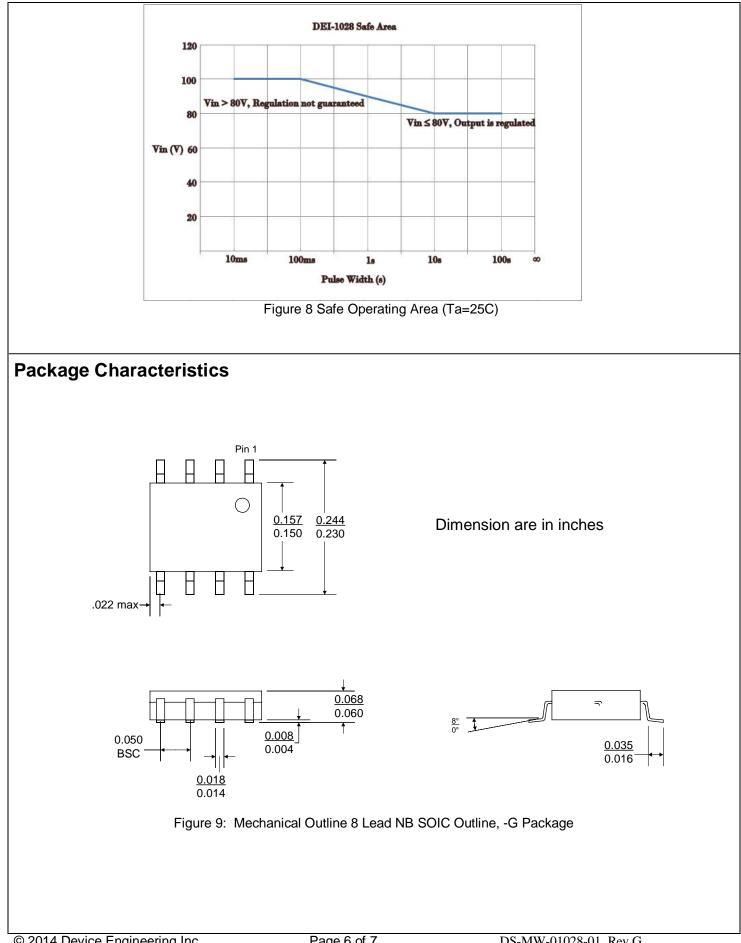


Table 6: Package Characteristics						
PACKAGE TYPE	8 Lead SOIC Narrow Body, Green					
REFERENCE	8L NB SOIC G					
$\begin{array}{l} \mbox{THERMAL RESISTANCE:} \\ \theta_{JA} & (4 \mbox{ layer PCB with Power Planes}) \\ \theta_{JC} \end{array}$	135 °C/W 40 °C/W					
JEDEC MOISTURE SENSITIVITY LEVEL (MSL)	MSL 1 / 260°C					
LEAD FINISH MATERIAL / JEDEC Pb-free CODE	NiPdAu e4					
Pb-Free DESIGNATION	RoHS Compliant					
JEDEC REFERENCE	MS-012-AC					

ORDERING INFORMATION

Table 7: Ordering Information						
PART NUMBER	MARKING	PACKAGE	Temperature			
DEI1028-SES-G	DEI1028 E4	8L NB SOIC G	-55 / +85 °C			
DEI1028–SKS-G	DEI1028 E4 + Blue Dot	8L NB SOIC G	-55 / +105 °C			

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